



#### Description

The AP120N06BD uses advanced trench technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = 60V I_{D} = 120A$ 

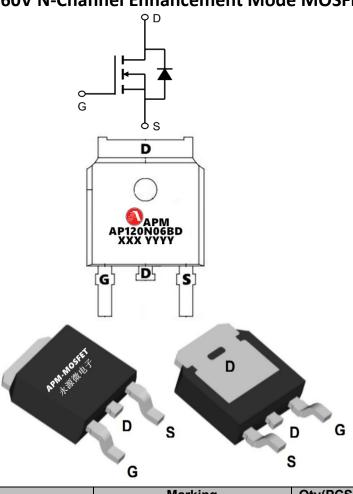
 $R_{DS(ON)} < 5.5 \text{m}\Omega$  @  $V_{GS}=10V$  (Type:  $4.5 \text{m}\Omega$ )

#### **Application**

Battery protection

Load switch

Uninterruptible power supply



**Package Marking and Ordering Information** 

Product ID	Pack	Marking	Qty(PCS)
AP120N06BD	TO-252-3L	AP120N06BD XXX YYYY	2500

Absolute Maximum Ratings@T<sub>j</sub>=25°C(unless otherwise specified)

Symbol	Parameter	Value	Unit
VDS	Drain source voltage	60	V
VGS	Gate source voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	120	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	53	А
IDM	Pulsed drain current <sup>2)</sup>	360	А
IAS	Diode forward current	29	А
P <sub>D</sub>	Power dissipation	123	W
EAS	Single pulsed avalanche energy <sup>)</sup>	206	mJ
Tstg, Tj	Operation and storage temperature	-55 to 150	°C
RθJC	Thermal resistance, junction-case	1.0	°C/W
RθJA	Thermal resistance, junction-ambient <sup>4)</sup>	62.5	°C/W

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## AP120N06BD

### **60V N-Channel Enhancement Mode MOSFET**

### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

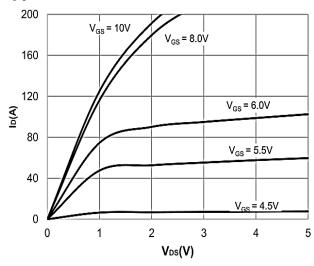
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	I <sub>D</sub> = 250mA, V <sub>GS</sub> = 0V	60	-	-	V
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 70V, V <sub>GS</sub> = 0V	-	-	1.0	mA
IGSS	Gate-Body Leakage Current	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250mA	2.0	3.0	4.0	V
RDS(ON)	Static Drain-Source ON-Resistance <sup>(4)</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A	-	4.5	5.5	mΩ
$R_g$	Gate Resistance	f = 1MHz	-	0.9	-	W
Ciss	Input Capacitance		-	5463	-	pF
Coss	Output Capacitance	$V_{GS} = 0V, V_{DS} = 35V, f = 1MHz$	-	250	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	199	-	pF
Qg	Total Gate Charge		-	94	-	nC
Qgs	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 35V$ , $I_{D} = 30A$	-	30	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge		-	24	-	nC
td(on)	Turn-On DelayTime		-	20	-	ns
tr	Turn-On Rise Time	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 35V	-	30	-	ns
td(off)	Turn-Off DelayTime	I <sub>D</sub> = 30A, R <sub>GEN</sub> = 3W	-	45	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	14	-	ns
IS	Maximum Continuous Body Diode Forward Current		-	-	120	Α
ISM	Maximum Pulsed Body Diode Forward Current		-	-	336	Α
VSD	Body Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	-		1.2	V
trr	Body Diode Reverse Recovery Time	1 00A 17/11 40CA	21	30	41	ns
Qrr	Body Diode Reverse Recovery Charge	I <sub>F</sub> = 30A, di/dt = 100A/us	-	41.8	-	nC

#### Note:

- 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2. The data tested by pulsed , pulse width .The EAS data shows Max. rating .
- 3. The test cond  $\leq$  300us duty cycle  $\leq$  2%, duty cycle ition is TJ =25  $^{\circ}$ C, VDD =35V, VG =10V, R G =25 $\Omega$ , L=0.5mH, IAS =29A
- 4. The power dissipation is limited by 175  $\!\!\!^{\circ}\!\!\!^{\circ}$  junction temperature
- 5. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

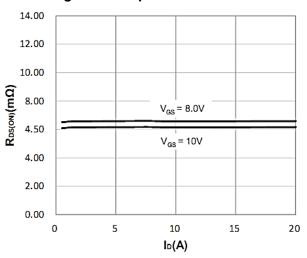


### **Typical Characteristics**



20 V<sub>DS</sub> = 5V T<sub>J</sub> = 125°C T<sub>J</sub> = -55°C T<sub>J</sub> = 25°C V<sub>GS</sub>(V)

**Figure 1: Output Characteristics** 



**Figure 2: Typical Transfer Characteristics** 

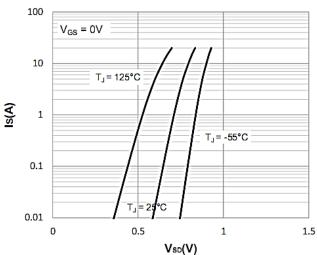
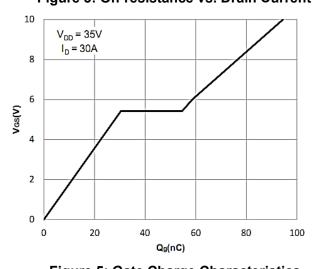


Figure 3: On-resistance vs. Drain Current



**Figure 4: Body Diode Characteristics** 

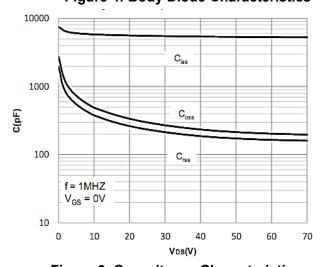
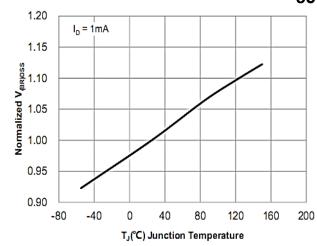


Figure 5: Gate Charge Characteristics

Figure 6: Capacitance Characteristics







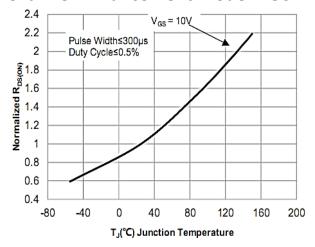
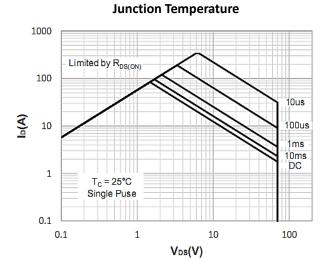


Figure 7: Normalized Breakdown voltage vs.

Figure 8: Normalized on Resistance vs.



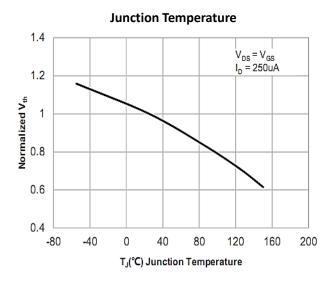


Figure 9: Maximum Safe Operating Area

Figure 13: Normalized Threshold Voltage vs.

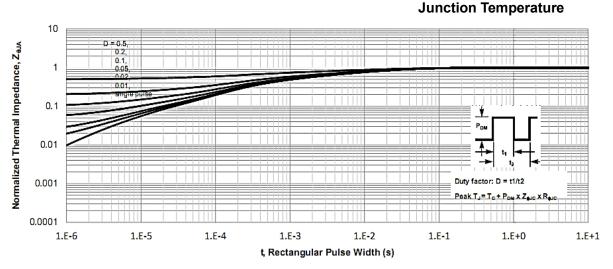


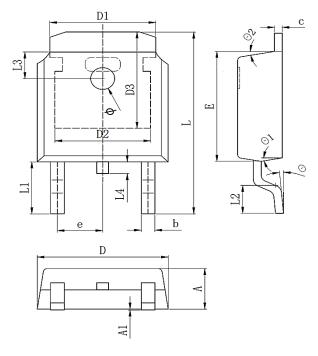
Figure 11: Normalized Maximum Transient Thermal Impedance

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# Package Mechanical Data-TO-252-3L



Cumbal	Dim in mm			
Symbol	Min	Тур	Max	
А	2.1	2.3	2.5	
A1	0	0.064	0.128	
b	0.64	0.75	0.86	
С	0.45	0.52	0.6	
D	6.4	6.6	6.8	
D1	5.33REF			
D2	4.83REF			
D3	5.25REF			
E	5.9	6.1	6.3	
е		2.286TYP		
L	9.8	10.1	10.4	
L1	2.888REF			
L2	1.4	1.5	1.7	
L3	1.65REF			
L4	0.6	0.8	1	
ф	1.1	1.2	1.3	
θ	0°		10°	
θ1	5°		10°	
θ2	5°		10°	



## AP120N06BD

#### 60V N-Channel Enhancement Mode MOSFET

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# **AP120N06BD**

### **60V N-Channel Enhancement Mode MOSFET**

Edition	Date	Change
REV1.0	2024/7/31	Initial release

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